

SKiiP® 3

2-pack-integrated intelligent Power System

SKiiP 1203 GB172-2DFW V3

Features

- SKiiP technology inside
- Trench IGBTs
- CAL HD diode technology
- Integrated current sensor
- Integrated temperature sensor
- · Integrated heat sink
- Fiber optic interface
- UL recognized File no. E63532

Typical Applications*

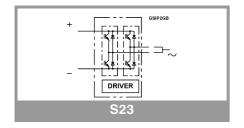
- Renewable energies
- Traction
- Elevators
- · Industrial drives

Footnotes

1) With assembly of suitable MKP capacitor per terminal

Absolute	Maximum Ratings		T _s = 25°C unless otherwise sp	ecified	
Symbol	Conditions		Values	Unit	
System					
V _{CC} 1)	Operating DC link v	roltage	1200	V	
V _{isol}	DC, t = 1 s, main te	rminals to heat sink	5600	V	
I _{t(RMS)}	per AC terminal, T _{te}	_{rminal} <115°C	400	Α	
I _{FSM}	$T_j = 150 {}^{\circ}\text{C}, t_p = 10$	ms, sin 180°	6900	Α	
l ² t	$T_j = 150 {}^{\circ}\text{C}, t_p = 10$	ms, diode	238	kA ² s	
f _{out}	fundamental output	frequency	1	kHz	
T _{stg}	storage temperatur	е	-40 85	°C	
IGBT					
V _{CES}	T _j = 25 °C		1700	V	
I _C	T _i = 150 °C	T _s = 25 °C	1159	Α	
	1 1 1 1 1 1 1 1 1 1	T _s = 70 °C	894	Α	
I _{Cnom}			1200	Α	
Tj	junction temperature		-40 150	°C	
Diode					
V_{RRM}	T _j = 25 °C		1700	V	
I _F	$T_{i} = 150 ^{\circ}\text{C}$ $T_{s} = 25 ^{\circ}\text{C}$		961	Α	
	1 1 1 1 1 1 1 1 1 1	T _s = 70 °C	733	Α	
I _{Fnom}	'		900	Α	
T_{j}	junction temperature		-40 150 °C		
Driver					
V _s	power supply		13 30	V	
V_{iH}	input signal voltage	(high)	15 + 0.3	V	
V_{isolPD}	QPD <= 10pC, PRI	M to POWER	1500	V	
dv/dt	secondary to prima	ry side	75	kV/μs	
f_{sw}	switching frequency	/	14	kHz	

Characteristics		$T_s = 25^{\circ}C u$	$t_s = 25^{\circ}$ C unless otherwise specified				
Symbol	Conditions		min.	typ.	max.	Unit	
IGBT							
V _{CE(sat)}	I _C = 600 A	T _j = 25 °C		1.9	2.4	V	
	at terminal	T _j = 125 °C		2.2		V	
V_{CE0}		T _j = 25 °C		1.00	1.20	V	
		T _j = 125 °C		0.90	1.10	V	
r _{CE}	at terminal	T _j = 25 °C		1.48	1.9	mΩ	
		T _j = 125 °C		2.1	2.5	mΩ	
$E_{on} + E_{off}$	$I_C = 600 \text{ A}$	$V_{CC} = 900 \text{ V}$		390		mJ	
	T _j = 125 °C	V _{CC} = 1200 V		575		mJ	
R _{th(j-s)}	per IGBT switch				0.026	K/W	
$R_{th(j-r)}$	per IGBT switch			·	0.028	K/W	





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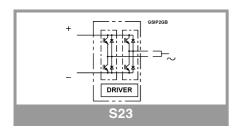
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Characte	ristics	٦	「 _s = 25°C เ	s = 25°C unless otherwise specified				
Symbol	Conditions		min.	typ.	max.	Unit		
Diode								
$V_F = V_{EC}$	I _F = 600 A	T _j = 25 °C		2.00	2.15	٧		
	at terminal	T _i = 125 °C		1.80		٧		
V_{F0}		T _j = 25 °C		1.1	1.2	٧		
		T _j = 125 °C		0.8	0.9	٧		
r _F	at taymin al	T _j = 25 °C		1.5	1.6	mΩ		
	at terminal	T _j = 125 °C		1.7	1.8	mΩ		
E _{rr}	I _F = 600 A	V _R = 900 V		72		mJ		
	T _j = 125 °C	V _R = 1200 V		86		mJ		
R _{th(j-s)}	per diode switch				0.05	K/W		
R _{th(j-r)}	per diode switch				0.062	K/W		
Driver	П		-I					
Vs	supply voltage non	stabilized	13	24	30	V		
I _{S0}	bias current @V _s =2			240		mA		
Is	$k_1 = 29 \text{ mA/kHz}, k_2$	= 0.00065 mA/A ²	= 240	+ k ₁ * f _{sw}	+ k ₂ * l _{AC} ²	mA		
V _{IT+}	input threshold volt	age (HIGH)	12.3			٧		
V _{IT-}	Input threshold volt	age (LOW)			4.6	٧		
R _{IN}	input resistance		10		kΩ			
C _{IN}	input capacitance			1		nF		
t _{pRESET}	error memory reset time			0.0122		ms		
t _{TD}	top / bottom switch interlock time			3		μs		
t _{jitter}	jitter clock time			125		ns		
t _{SIS}	short pulse suppression time			0.625	0.7	μs		
I _{TRIPSC}	over current trip lev	over current trip level		1250	1275	A _{PEAK}		
T _{trip}	over temperature trip level		110	115	120	°C		
V_{DCtrip}	over voltage trip level,			not impl.		٧		
t _{d(on)IO}	V _{CC} = 1200 V I _C = 600 A	input-output turn-on propagation time		1.4		μs		
$t_{\text{d(off)IO}}$	T _j = 25 °C	input-output turn-off propagation time		1.4		μs		
System			1					
$R_{th(r-a)}$	flow rate=8l/min, T _F glycol ratio 50%:50	%			0.012	K/W		
R _{CC'+EE'}	measured per switch			0.25		mΩ		
L _{CE}	commutation induc			6		nH		
C _{CHC}	per phase, AC-side			2		nF		
I _{CES} + I _{RD}	$V_{GE} = 0 \text{ V}, V_{CE} = 17$	•		2.4		mA		
M _{dc}	DC terminals, SI Ur		6		8	Nm		
M _{ac}	AC terminals, SI Ur		13		15	Nm		
W	SKiiP System w/o h	neat sink		1.7		kg		
Wh	heat sink			2.8		kg		

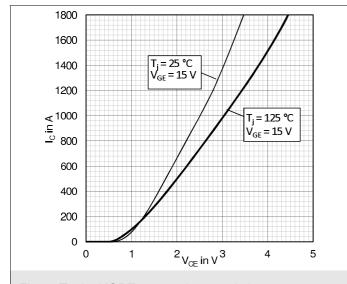


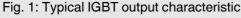
Isolation coordination acc. to EN 50178 and IEC 61800-5-1	
Maximum grid RMS voltage, line-to-line, star point grounded mains	690V+20%
Installation altitude for maximum grid RMS voltage, line-to-line, star point grounded mains	2000m
Maximum transient peak voltage between low voltage circuit and mains	1600V
Pollution degree acc. to IEC 60664-1 outside the moulded power section	2
Overvoltage cat. acc. to IEC 60664-1 for mains	III
Basic isolation	between heat sink and mains; between low voltage circuit and mains
Protection level acc. to IEC 60529	IP00

Environmental conditions acc.to IEC 60721

	Storage	Transportation	Operation stationary use at weather protected locations	Operating ground vehicle installations	Operating ship environment
Climatic conditions	1K2 ₍₁₎	2K2 ₍₁₎	3K3 ₍₁₎	5K1 ₍₁₎	
Biological conditions	1B1	2B1	3B1	5B1	6B1
Chemically active substances (excluded: salt spray)	1C2	2C1	3C2	5C2	6C2
Mechanically active substances	181	281	3S1	581	6S1
Mechanical conditions	1M3	(4)	3M6 ₍₂₎	5M3 ₍₃₎	6M3
Contaminating fluids				5F1	

- (1) expanded temperature range: -40°C / +85°C. Please note: by operation near 85°C the life time of product is reduced.
- (2) 3M7 possible, but due to the mechanic load capacity of external components like DC-Link capacitors limited to 3M6
- (3) 5M3 without impact of foreign bodies, stones
- (4) no declaration due to customer-specific packing





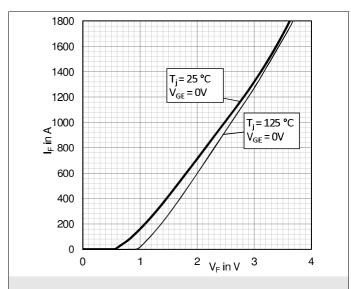


Fig. 2: Typical diode output characteristics

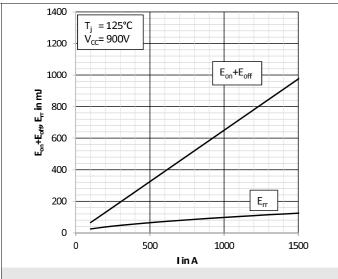


Fig. 3: Typical energy losses $E = f(I_c, V_{cc})$

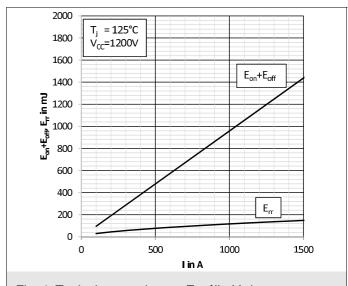


Fig. 4: Typical energy losses $E = f(I_c, V_{cc})$

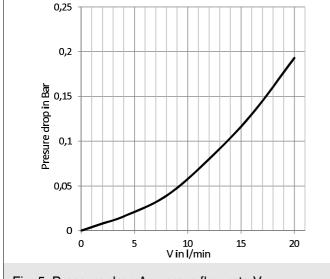


Fig. 5: Pressure drop Δp versus flow rate V

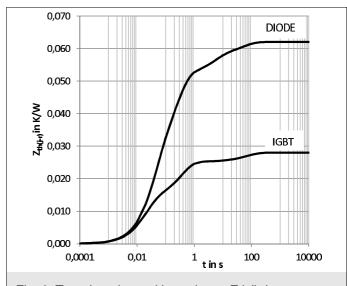


Fig. 6: Transient thermal impedance Zth(j-r)

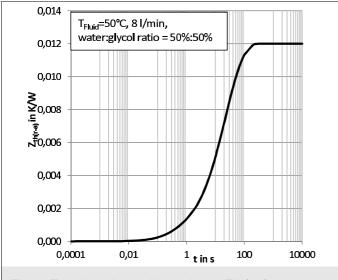


Fig. 7: Transient thermal i	impedance Zth(r-a)
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	Rth [K/W]							
	1 2 3 4 5							
Zth(j - r) I	0,0028	0,0116	0,0136	0,0000	0,0000			
Zth(j - r) D	0,0040	0,0060	0,0260	0,0260	0,0000			
Zth(r-a)	0,0055	0,0048	0,0011	0,0006	0,0000			
		tau [s]						
	1	2	3	4	5			
Zth(j - r) I	69,000	0,3500	0,0200	1,0000	1,0000			
Zth(j - r) D	50,000	5,0000	0,2500	0,0400	1,0000			
Zth(r-a)	48,000	14,600	2,8000	0,3500	1,0000			

Fig. 8: Coefficients of thermal impedances

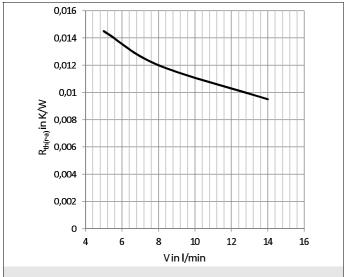
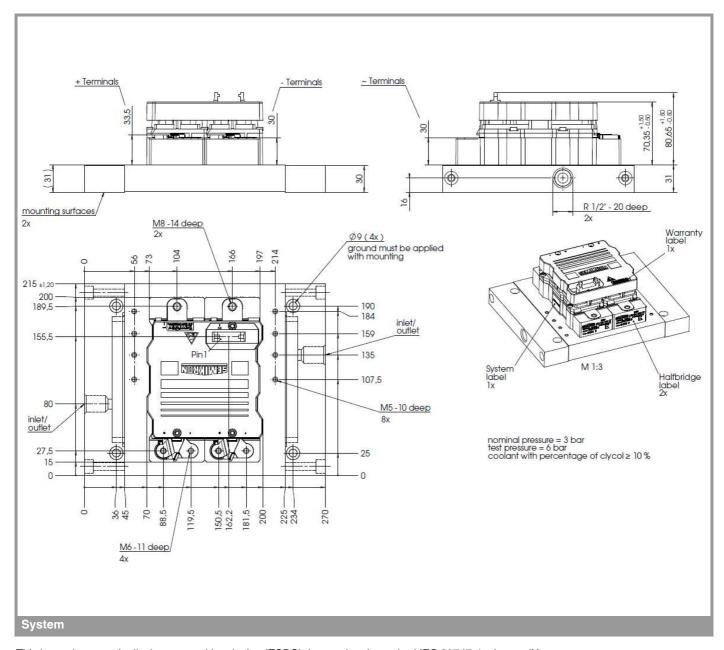


Fig. 9: Thermal resistance Rth(r-a) versus flow rate V



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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